

IN THE
United States Patent and Trademark Office

Applicant(s): Kazumitsu Seki, et al. **Docket No.:** 17314-018
Serial No.: 10/599,661 **Art Unit:** 4116
Filed: October 4, 2006 **Examiner:** Chen, Yu
For: Palladium-Plated Lead Finishing Structure For Semiconductor Part And Method
Of Producing Semiconductor Device

Mailstop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT AND RESPONSE

Further to the Non-Final Office Action dated February 26, 2009 (hereinafter "Office Action"),
in view of the following amendments and/or remarks, Applicants request entry thereof and
reconsideration of the above-referenced application.

Amendments to the Drawings are discussed beginning on page 2 and are included as a
Replacement Sheet in Attachment A.

Amendments to the Claims are included starting on page 3.

A **Remarks** section is included starting on page 5.